Near Field Communication (NFC) controller

Rev. 01 - 31 December 2008

Product short data sheet

1. General description

The PN5331B3HN is a highly integrated transceiver module for contactless communication at 13.56 MHz based on the 80C51 microcontroller core.

A dedicated ROM code is implemented to handle different RF protocols.

RF protocols

PN5331B3HN supports four main operating modes:

- ISO/IEC 14443A Reader/Writer (incl. MIFARE product family)
- ISO/IEC 14443B Reader/Writer
- FeliCa Reader/Writer
- ISO/IEC 18092, ECMA 340 Peer-to-Peer

The PN5331B3HN hardware implements a demodulator and decoder for signals from ISO/IEC 14443A compatible cards and transponders. The PN5331B3HN hardware handles the complete ISO/IEC 14443A framing and error detection and upper layers of this protocol (i.e. ISO/IEC 14443-4) are implemented in firmware.

The PN5331B3HN supports all MIFARE products (e.g. MIFARE crypto method). It supports contactless communication using higher transfer speeds up to 848 kbit/s in both directions.

The PN5331B3HN hardware supports layers 2 and 3 of the ISO/IEC 14443B Reader/Writer communication scheme, except anticollision. Anticollision is implemented in firmware as well as upper layers (i.e. ISO/IEC 14443-4).

The PN5331B3HN can demodulate and decode FeliCa coded signals. The PN5331B3HN handles the FeliCa framing and error detection. It supports contactless communication using FeliCa Higher transfer speeds up to 424 kbit/s in both directions.

Compliant to ECMA 340 and ISO/IEC 18092 NFCIP-1 Passive and Active communication modes, the PN5331B3HN/C270 offers the possibility to communicate to another NFCIP-1 compliant device, at transfer speeds up to 424 kbit/s. The PN5331B3HN handles the complete NFCIP-1 framing and error detection.

Interfaces

The PN5331B3HN supports USB 2.0 full speed interface (bus powered or host powered mode).

PN5331B3HN has also a master I²C interface enabling the drive of following peripherals:

- An external EEPROM
- · A TDA8029 smart card reader



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Standards compliancy

PN5331B3HN offers commands in order for applications to be compliant with "Paypass-ISO/IEC 14443 Implementation v1.1" and "EMV Contactless Communication Protocol Specification v2.0".

PN5331B3HN supports RF protocols ISO/IEC 14443A and B such as compliancy with Smart eID standard can be achieved at application level.

A dedicated command is implemented in PN5331B3HN firmware to support NFC secure applications in accordance with "NFC sec Security layer for NFC" specification in order to enable USB wireless or BT enabler applications in a host baseband.

2. Features

- 80C51 microcontroller core with 45056 bytes ROM and 1224 bytes RAM
- Highly integrated demodulator and decoder
- Buffered output drivers to connect an antenna with minimum number of external components
- Integrated RF level detector
- Integrated data mode detector
- Supports ISO/IEC 14443A Reader/Writer mode up to 848 kbit/s
- Supports ISO/IEC 14443B Reader/Writer mode up to 848 kbit/s
- Supports MIFARE encryption in Reader/Writer mode and higher transfer speed communication at 212 kbit/s, 424 kbit/s and 848kbit/s
- Supports contactless communication according to the FeliCa protocol at 212 kbit/s and 424 kbit/s
- Typical operating distance in Reader/Writer mode for communication to ISO/IEC 14443A/MIFARE, ISO/IEC 14443B or FeliCa cards up to 50 mm depending on antenna size and tuning
- Support NFCIP-1 mode up to 424 kbit/s
- Typical operating distance in NFCIP-1 mode up to 50 mm depending on antenna size, tuning and power supply
- Supported USB 2.0 full speed interface
- Restricted I²C master interface to control an external I²C EEPROM or TDA8029 smart card reader
- Low power modes
 - Hard-Power-Down mode
 - ◆ Soft-Power-Down mode
- 27.12 MHz Crystal oscillator
- On-Chip PLL to generate internally 96 MHz for the USB interface
- Power modes
 - ◆ USB bus power mode
 - ◆ 2.5 V to 3.6 V power supply operating range in non USB bus power mode
- Dedicated IO ports for external device control

3. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{BUS}	USB supply voltage (USB mode)			4.02	5	5.25	V
	supply voltage (non USB mode)	$V_{BUS} = DV_{DD}$ $DV_{SS} = 0 V$		2.5	3.3	3.6	V
$TV_DD,AV_DD,\ DV_DD$	supply voltage	$TV_{DD} = AV_{DD} = DV_{DD}$ $V_{SS} = 0 V$	<u>[1]</u>	2.5	3.3	3.6	V
PV_{DD}	supply voltage for host interface	V _{SS} = 0 V		1.6	-	3.6	V
SV _{DD}	supply voltage reserved for future use	V _{SS} = 0 V		DV _{DD} -0.1	-	DV_DD	V
I_{VBUS}	maximum load current (USB mode)	measured on V_{BUS}		-	-	150	mA
	maximum inrush current limitation	at power up (curlimoff =0)		-	-	100	mA
I _{HPD}	hard-power-down current (not powered from USB)	$AV_{DD} = DV_{DD} = TV_{DD} =$ $PV_{DD} = 3 \text{ V, RF level}$ detector off		-	-	10	μΑ
I _{SPD}	soft-power-down current (not powered from USB)	$AV_{DD} = DV_{DD} = TV_{DD} =$ $PV_{DD} = 3 \text{ V, RF level}$ detector on		-	-	30	μА
I _{suspend}	USB suspend current	$AV_{DD} = DV_{DD} = TV_{DD} =$ $PV_{DD} = 3 \text{ V, RF level}$ detector on, (without resistor on DP/DM)		-	-	250	μА
I _{DVDD}	digital supply current	$AV_{DD} = DV_{DD} = TV_{DD} =$ $PV_{DD} = 3 \text{ V, RF level}$ detector on, SV_{DD} switch off	[1]	-	15	-	mA
I _{SVDD}	SV _{DD} load current	SV _{DD} = 3 V		-	-	30	mA
I _{AVDD}	analog supply current	$AV_{DD} = DV_{DD} = TV_{DD} =$ $PV_{DD} = 3 \text{ V, RF level}$ detector on		-	6	-	mA
I _{TVDD}	transmitter supply current	during RF transmission, $TV_{DD} = 3 V$		-	60	100	mA
P _{tot}	total power dissipation	T_{amb} = -30 to +85 °C		-	-	0.55	W
T _{amb}	ambient temperature			-30	_	+85	°C

^[1] $\,$ DV_{DD}, AV_{DD} and TV_{DD} must always be at the same supply voltage.

4. Ordering information

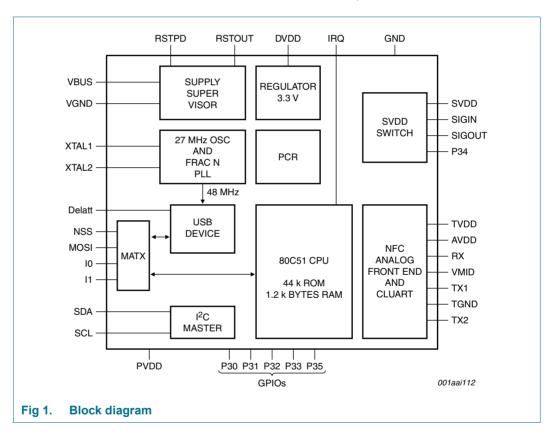
Table 2. Ordering information

Type number Package			
	Name	Description	Version
PN5331B3HN/C270[1][2]	HVQFN40	Heatsink Very thin Quad Flat package; 40 pins, plastic, body 6 x 6 x 0.85 mm; leadless; MSL level 2.	SOT618-1

^{[1] 70} refers to the ROM code version described in User Manual.

5. Block diagram

The following block diagram describes hardware blocks controlled by PN5331B3HN firmware or which can be accessible for data transaction by a host baseband.



^[2] Refer to Section 9.4 "Licenses"

6. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$\begin{array}{l} PV_{DD}, \\ SV_{DD}, \\ TV_{DD}, \\ AV_{DD}, \\ DV_{DD} \end{array}$	supply voltage		-0.5	4	V
V_{BUS}	USB supply voltage		-0.5	5.5	V
P _{tot}	total power dissipation		-	500	mW
I_{SVDD}	maximum current in SVDD switch		-	30	mA
V_{INRX}	dynamic RX input voltage range		-0.5	4	V
V_{INTX1}	dynamicTX1 input voltage range		-0.5	4	V
V_{INTX2}	dynamic TX2 input voltage range		-0.5	4	V
V _{ESD}	electrostatic discharge voltage				
V_{ESDH}	ESD susceptibility (human body model)	1500 Ω , 100pF; EIA/JESD22-A114-A	-	±2.0	kV
V_{ESDM}	ESD susceptibility (machine model)	0.75 mH, 200 pF; EIA/JESD22-A115-A	-	200	V
V_{ESDC}	ESD susceptibility (charge device model)	field induced model; EIA/JESC22-C101-C	-	±1	kV
T _{stg}	storage temperature		-55	150	°C
T _j	junction temperature		-40	125	°C

7. Abbreviations

Table 4. Abbreviations

Acronym	Description
CRC	Cyclic Redundancy Check
EEPROM	Electrically Erasable Programmable Read-Only Memory
HPD	Hard Power Down
NFC	Near Field Communication
SPD	Soft Power Down mode

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8. Revision history

Table 5. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PN5331B3HN_SDS_N_1	20081231	Product short data sheet	-	-

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9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
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RATP/Innovatron Technology

Purchase of NXP ICs with NFC technology

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